

Abstract

Method and device for determining a parameter for the reproducible production of raised contact metallizations (24, 25) on terminal areas of a substrate by means of depositing a metallization material in a metallization bath, a test substrate having at least two terminal areas adjacent at a defined spacing being introduced into the metallization bath (10) and the parameter being determined from the variation in an electrical quantity as a consequence of an electrical contact resulting from the deposition of the metallization material for building up the contact metallizations (24, 25) on the adjacent terminal areas.

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(Figure 3)